4-Bit Dual-Supply Inverting Level Translator

The NLSV4T240E is a 4-bit configurable dual-supply voltage level translator. The input A_n and output B_n ports are designed to track two different power supply rails, V_{CCA} and V_{CCB} respectively. Both supply rails are configurable from 0.9 V to 4.5 V allowing universal low-voltage translation from the input A_n to the output B_n port.

The NLSV4T240E is similar to the NLSV4T240; however, it has enhanced power-off characteristics.

Features

- Wide V_{CCA} and V_{CCB} Operating Range: 0.9 V to 4.5 V
- High-Speed w/ Balanced Propagation Delay
- Inputs and Outputs have OVT Protection to 4.5 V
- Non-preferential V_{CCA} and V_{CCB} Sequencing
- Outputs at 3-State until Active V_{CC} is Reached
- Power-Off Protection
- Outputs Switch to 3-State with V_{CCB} at GND
- Ultra-Small Packaging: 1.7 mm x 2.0 mm UQFN12
- This is a Pb–Free Device

Typical Applications

• Mobile Phones, PDAs, Other Portable Devices

Important Information

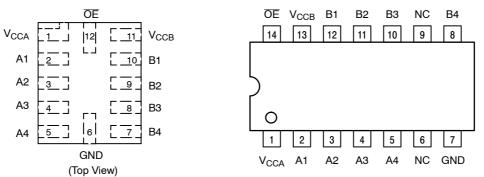
- ESD Protection for All Pins:
 - HBM (Human Body Model) > 6000 V MM (Machine Model) > 300 V

OI	ON N Semicond	uctor®
	http://onsemi.	com
		MARKING DIAGRAMS
	UQFN12 MU SUFFIX CASE 523AE	AEM•
M •	E = Specific Devic = Date Code = Pb-Free Pack icrodot may be in ei	age
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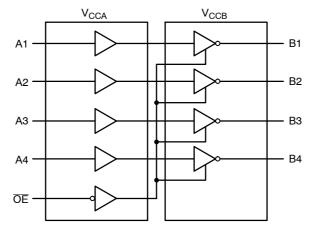
ORDERING INFORMATION

Device	Package	Shipping [†]
NLSV4T240EMUTAG	UQFN12 (Pb-Free)	3000/Tape & Reel
NLSV4T240EDR2G	SO-14 (Pb-Free)	2500/Tape & Reel
NLSV4T240EDTR2G	TSSOP14 (Pb-Free)	2500/Tape & Reel

+ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.









PIN ASSIGNMENT

Pin	Function
V _{CCA}	Input Port DC Power Supply
V _{CCB}	Output Port DC Power Supply
GND	Ground
A _n	Input Port
B _n	Output Port
ŌĒ	Output Enable

TRUTH TABLE

In	Outputs	
ŌĒ	A _n	B _n
L	L	Н
L	Н	L
Н	х	3-State

MAXIMUM RATINGS

Symbol	Rating		Value	Condition	Unit
V_{CCA}, V_{CCB}	DC Supply Voltage		-0.5 to +5.5		V
VI	DC Input Voltage	An	-0.5 to +5.5		V
V _C	Control Input	ŌĒ	-0.5 to +5.5		V
V _O	DC Output Voltage (Power Down)	B _n	-0.5 to +5.5	$V_{CCA} = V_{CCB} = 0$	V
	(Active Mode)	B _n	-0.5 to +5.5		V
	(Tri-State Mode)	B _n	-0.5 to +5.5		V
I _{IK}	DC Input Diode Current		-20	V _I < GND	mA
I _{OK}	DC Output Diode Current		-50	V _O < GND	mA
Ι _Ο	DC Output Source/Sink Current		±50		mA
I _{CCA} , I _{CCB}	DC Supply Current Per Supply Pin		±100		mA
I _{GND}	DC Ground Current per Ground Pin		±100		mA
T _{STG}	Storage Temperature		-65 to +150		°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Мах	Unit	
V_{CCA}, V_{CCB}	Positive DC Supply Voltage		0.9	4.5	V
VI	Bus Input Voltage	GND	4.5	V	
V _C	Control Input	GND	4.5	V	
V _{IO}	Bus Output Voltage (Power Down Mode)	B _n	GND	4.5	V
	(Active Mode)	B _n	GND	V _{CCB}	V
	(Tri-State Mode)	B _n	GND	4.5	V
T _A	Operating Temperature Range		-40	+85	°C
$\Delta t / \Delta V$	Input Transition Rise or Rate V _I , from 30% to 70% of V _{CC} ; V _{CC} = 3.3 V ± 0.3 V		0	10	nS

DC ELECTRICAL CHARACTERISTICS

					–40°C te	o +85°C	
Symbol	Parameter	Test Conditions	V _{CCA} (V)	V _{CCB} (V)	Min	Max	Unit
V _{IH}	Input HIGH Voltage		3.6 - 4.5	0.9 - 4.5	2.7	-	V
	(An, ŌE)		2.7 – 3.6		2.0	-	
			2.3 – 2.7		1.7	-	
			1.4 – 2.3		0.75 * V _{CCA}	-	
			0.9 – 1.4		0.9 * V _{CCA}	-	
V _{IL}	Input LOW Voltage		3.6 – 4.5	0.9 - 4.5	-	0.8	V
	(An, ŌE)		2.7 – 3.6		-	0.8	
			2.3 – 2.7		-	0.7	
			1.4 – 2.3		-	0.35 * V _{CCA}	
			0.9 – 1.4	1	-	0.1 * V _{CCA}	

DC ELECTRICAL CHARACTERISTICS

					–40°C to	+85°C	
Symbol	Parameter	Test Conditions	V _{CCA} (V)	V _{CCB} (V)	Min	Max	Unit
V _{OH}	Output HIGH Voltage	I_{OH} = -100 μ A; V _I = V _{IH}	0.9 – 4.5	0.9 – 4.5	$V_{CCB} - 0.2$	-	V
		I_{OH} = -0.5 mA; V_I = V_{IH}	0.9	0.9	0.75 * V _{CCB}	-	1
		$I_{OH} = -2 \text{ mA}; V_I = V_{IH}$	1.4	1.4	1.05	-	1
		$I_{OH} = -6 \text{ mA}; \text{ V}_{I} = \text{V}_{IH}$	1.65	1.65	1.25	-	1
			2.3	2.3	2.0	-	1
		$I_{OH} = -12 \text{ mA}; V_I = V_{IH}$	2.3	2.3	1.8	-	1
			2.7	2.7	2.2	-	1
		I_{OH} = -18 mA; V_I = V_{IH}	2.3	2.3	1.7	-	1
			3.0	3.0	2.4	-	1
		I_{OH} = -24 mA; V_I = V_{IH}	3.0	3.0	2.2	-	1
V _{OL}	Output LOW Voltage	$I_{OL} = 100 \ \mu A; \ V_I = V_{IL}$	0.9 – 4.5	0.9 – 4.5	-	0.2	V
		I_{OL} = 0.5 mA; V_I = V_{IH}	1.1	1.1	-	0.3	1
		$I_{OL} = 2 \text{ mA}; V_I = V_{IH}$	1.4	1.4	-	0.35	1
		$I_{OL} = 6 \text{ mA}; V_I = V_{IL}$	1.65	1.65	-	0.3	1
		I_{OL} = 12 mA; $V_I = V_{IL}$	2.3	2.3	-	0.4	1
			2.7	2.7	-	0.4	1
		I_{OL} = 18 mA; $V_I = V_{IL}$	2.3	2.3	-	0.6	1
			3.0	3.0	-	0.4	1
		I_{OL} = 24 mA; V_I = V_{IL}	3.0	3.0	-	0.55	1
Ι	Input Leakage Current	$V_I = V_{CCA}$ or GND	0.9 - 4.5	0.9-4.5	-1.0	1.0	μA
I _{OFF}	Power-Off Leakage Current	<u>OE</u> = 0 V	0 0.9 – 4.5	0.9-4.5 0	-1.0 -1.0	1.0 1.0	μA
I _{CCA}	Quiescent Supply Current		0.9 - 4.5	0.9 – 4.5	-	2.0	μA
I _{CCB}	Quiescent Supply Current		0.9-4.5	0.9 – 4.5	-	2.0	μΑ
CCA + I _{CCB}	Quiescent Supply Current		0.9-4.5	0.9 – 4.5	-	4.0	μΑ
ΔI_{CCA}	Increase in $I_{\rm CC}$ per Input Voltage, Other Inputs at $V_{\rm CCA}$ or GND		4.5 3.6	4.5 3.6	-	10 5.0	μA
ΔI_{CCB}	Increase in I_{CC} per Input Voltage, Other Inputs at V_{CCA} or GND	$V_{I} = V_{CCA} - 0.6 V;$ $V_{I} = V_{CCA}$ or GND	4.5 3.6	4.5 3.6	-	10 5.0	μA
I _{OZ}	I/O Tri-State Output Leakage	V _O = 0 V	4.5	4.5	-	1.0	μA
	Current ($T_A = 25^{\circ}C$, $\overline{OE} = V_{CCA}$)	V _O = 4.5 V	4.5	4.5	-	10	1
		V _O = 0 to 4.5 V	2.5	3.5	-	105	1
			3.0	3.75	-	110	1
			3.3	3.0	-	75	1
			3.75	1.5	- 1	10	

TOTAL STATIC POWER CONSUMPTION (I_{CCA} + I_{CCB})

	-40°C to +85°C												
		V _{CCB} (V)											
	4.5 3.3			.3	2	.8	1.	8	0.	.9			
V _{CCA} (V)	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Unit		
4.5		2		2		2		2		< 1.5	μA		
3.3		2		2		2		2		< 1.5	μA		
2.8		< 2		< 1		< 1		< 0.5		< 0.5	μA		
1.8		< 1		< 1		< 0.5		< 0.5		< 0.5	μA		
0.9		< 0.5		< 0.5		< 0.5		< 0.5		< 0.5	μA		

NOTE: Connect ground before applying supply voltage V_{CCA} or V_{CCB}. This device is designed with the feature that the power-up sequence of V_{CCA} and V_{CCB} will not damage the IC.

AC ELECTRICAL CHARACTERISTICS

							-40°C t	o +85°C					
							Vcc	_в (V)					
			4.	.5	3.3		2	2.8		.8	1.5		
Symbol	Parameter	V _{CCA} (V)	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Unit
t _{PLH} ,	Propagation	4.5		3.0		3.2		3.4		3.7		4.0	nS
t _{PHL} (Note 1)	Delay,	3.6		3.3		3.5		3.7		4.0		4.3	
(Note I)	A _n to B _n	2.8		3.5		3.7		3.9		4.2		4.5	
		1.8		3.8		4.0		4.2		4.5		4.8	
		1.5		4.1		4.3		4.5		4.8		5.0	
t _{PZH} ,	Output	4.5		4.4		4.8		5.2		5.7		6.2	nS
t _{PZL}	Enable,	3.3		4.7		5.1		5.5		6.0		6.5	
(Note 1)	OE to B _n	2.8		4.9		5.3		5.7		6.2		6.7	
		1.8		5.2		5.6		6.0		6.5		7.0	
		1.5		5.5		5.9		6.3		6.8		7.3	
t _{PHZ} ,	Output	4.5		4.4		4.8		5.2		5.7		6.2	nS
t _{PLZ}	Disable,	3.3		4.7		5.1		5.5		6.0		6.5	
(Note 1)	OE to B _n	2.8		4.9		5.3		5.7		6.2		6.7	
		1.8		5.2		5.6		6.0		6.5		7.0	
		1.5		5.5		5.9		6.3		6.8		7.3	
t _{OSHL} ,	HL, Output to	4.1		0.15		0.15		0.15		0.15		0.15	nS
t _{OSLH}	Output Skew, Data to Out-	3.6		0.15		0.15		0.15		0.15		0.15	
(Note 1)	put	2.8		0.15		0.15		0.15		0.15		0.15	
		1.8		0.15		0.15		0.15		0.15		0.15	
		1.2		0.15		0.15		0.15		0.15		0.15	

1. Propagation delays defined per Figures 3 and 4.

CAPACITANCE

Symbol	Parameter	Test Conditions	Typ (Note 2)	Unit
C _{IN}	Control Pin Input Capacitance	$V_{CCA} = V_{CCB} = 3.3 \text{ V}, V_I = 0 \text{ V or } V_{CCA/B}$	3.5	pF
C _{I/O}	I/O Pin Input Capacitance	V_{CCA} = V_{CCB} = 3.3 V, V_{I} = 0 V or $V_{CCA/B}$	5.0	pF
C _{PD}	Power Dissipation Capacitance	V_{CCA} = V_{CCB} = 3.3 V, V_{I} = 0 V or V_{CCA},f = 10 MHz	20	pF

2. Typical values are at $T_A = +25^{\circ}C$. 3. C_{PD} is defined as the value of the IC's equivalent capacitance from which the operating current can be calculated from: $I_{CC(operating)} \cong C_{PD} \times V_{CC} \times f_{IN} \times N_{SW}$ where $I_{CC} = I_{CCA} + I_{CCB}$ and N_{SW} = total number of outputs switching.

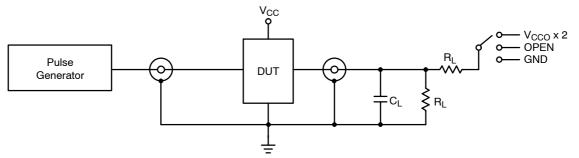
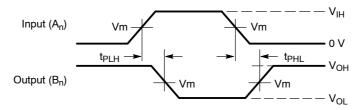


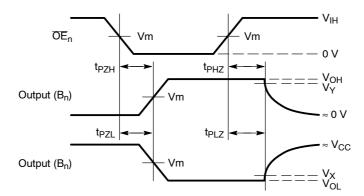
Figure 3. AC (Propagation Delay) Test Circuit

Test	Switch
t _{PLH} , t _{PHL}	OPEN
t _{PLZ} , t _{PZL}	V _{CCO} x 2
t _{PHZ} , t _{PZH}	GND
C_L = 15 pF or equivalent (include R_L = 2 k Ω or equivalent Z_{OUT} of pulse generator = 50 Ω	es probe and jig capacitance)



Waveform 1 – Propagation Delays

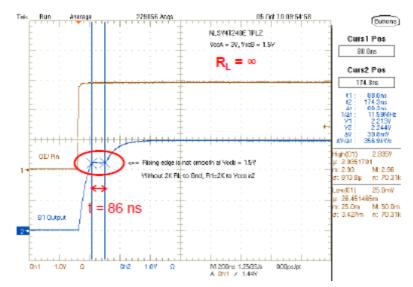
 t_{R} = t_{F} = 2.0 ns, 10% to 90%; f = 1 MHz; t_{W} = 500 ns

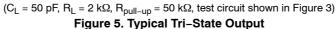


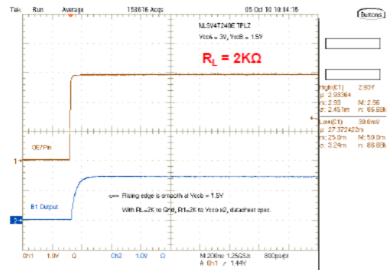
Waveform 2 – Output Enable and Disable Times t_R = t_F = 2.0 ns, 10% to 90%; f = 1 MHz; t_W = 500 ns

	V _{CC}				
Symbol	3.0 V – 4.5 V	2.3 V – 2.7 V	1.65 V – 1.95 V	1.4 V – 1.6 V	0.9 V – 1.3 V
V _{mA}	V _{CCA} /2				
V _{mB}	V _{CCB} /2				
V _X	V _{OL} x 0.1				
V _Y	V _{OH} x 0.9				

APPLICATIONS INFORMATION







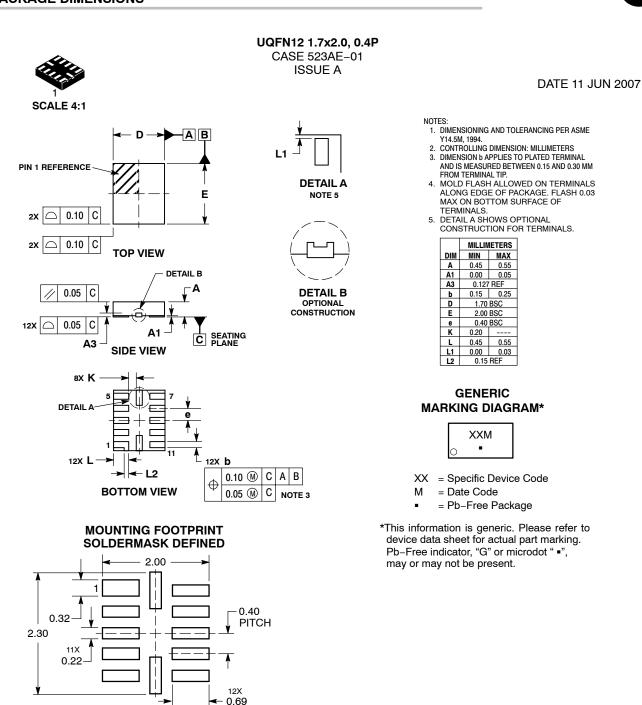
 $(C_L = 50 \text{ pF}, R_L = \infty, R_{Pull-up} = 2 \text{ k}\Omega, \text{ test circuit shown in Figure 3})$ Figure 6. Typical Tri–State Output

Typical tri-state output waveforms of the NLSX4T240E are shown in Figures 5 and 6. The shape of the output waveform during a tri-state condition corresponding to the disable time (t_{PHZ} , t_{pLZ}) depends on the configuration of the pull-up circuit. Figure 5 shows a smooth monotonically increasing exponentially waveform because a 2 k Ω resistance is connected between the output and ground.

Figure 6 shows that the output may have a 'shelf' or a short duration where the slope of the waveform is equal to zero if no load resistance is connected to ground. The NLSX4T240E was created from the NLSX4T240 to minimize the 'shelf' of the waveform during the disable time.

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS





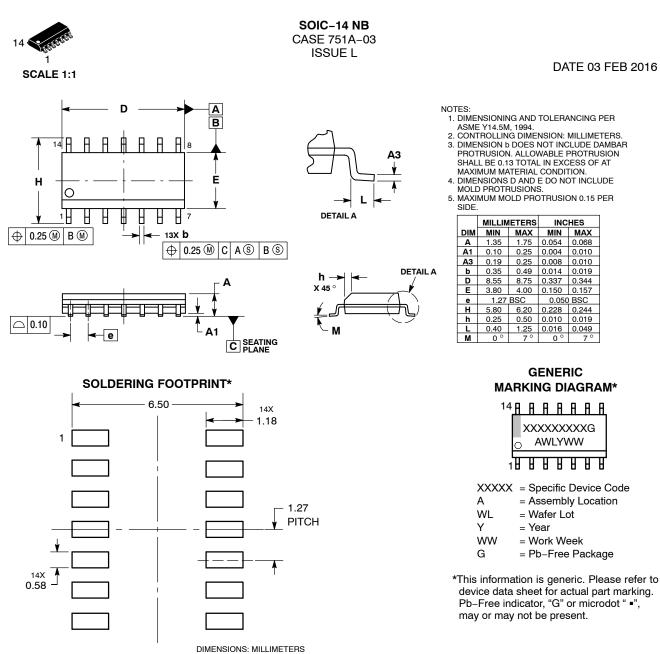
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*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

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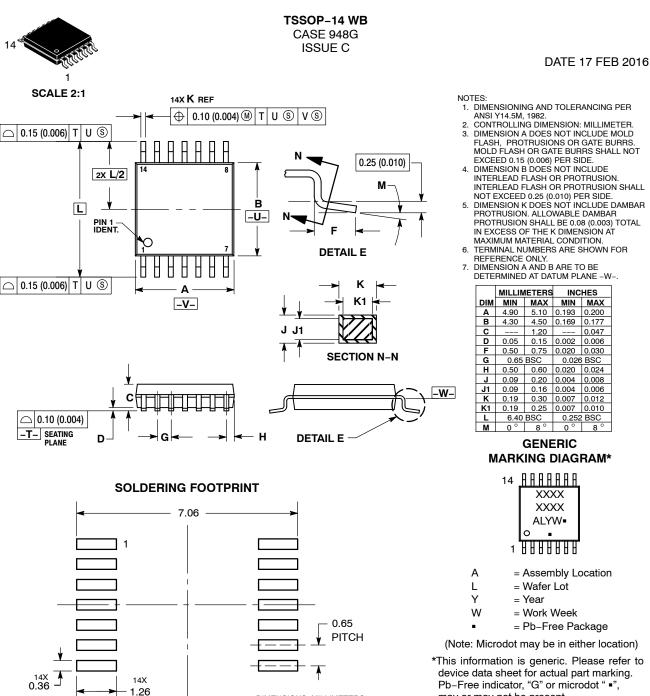
DATE 03 FEB 2016

STYLE 1: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 2: CANCELLED	STYLE 3: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 9. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE	STYLE 4: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 8. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE
STYLE 5: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. NO CONNECTION 7. COMMON ANODE 8. COMMON CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 6: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 8. ANODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE	STYLE 7: PIN 1. ANODE/CATHODE 2. COMMON ANODE 3. COMMON CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. ANODE/CATHODE 7. ANODE/CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. COMMON CATHODE 12. COMMON CATHODE 13. ANODE/CATHODE 14. ANODE/CATHODE	STYLE 8: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. ANODE/CATHODE 7. COMMON ANODE 8. COMMON ANODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. NO CONNECTION 12. ANODE/CATHODE 13. ANODE/CATHODE 14. COMMON CATHODE

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